

IN THE CLAIMS:

This listing of claims will replace all prior versions, and listings, of claims in the application:

1. (Currently Amended) A light-emitting device, comprising:

- a first substrate;
- a luminous element provided over said first substrate;
- a current control TFT provided over said first substrate;
- a current supply line provided over said first substrate and connected with said luminous element via said current control TFT;
- a second substrate;
- a wiring for aiding said current supply line, said wiring for aiding said current supply line provided over said second substrate and electrically connected to said current supply line; and
- a conductor for electrically connecting said current supply line and said wiring for aiding said current supply line,

wherein the luminous element is located between the first substrate and the second substrate.

2. (Original) A device according to claim 1, wherein said luminous element is an EL element.

3. (Original) A device according to claim 1, wherein said wiring for aiding said current supply line is made of a metallic film selected from the group consisting of copper, silver, gold, aluminum and nickel, or an alloy film containing as a main component a material selected from the group consisting of copper, silver, gold, aluminum, and nickel.

4. (Original) A device according to claim 1, wherein said wiring for aiding said current supply line is formed into a layered structure made of a metallic film that is made of two or more different elements selected from copper, silver, gold, aluminum and nickel.

5. (Previously Presented) A device according to claim 1, wherein said wiring for aiding said current supply line is formed on a front surface of said second substrate, on a back surface thereof, or in the interior thereof.

6. (Previously Presented) A device according to claim 1, wherein a via hole that is covered by said wiring for aiding said current supply line is formed in said second substrate.

7. (Currently Amended) A light-emitting device, comprising:

- a first substrate;
- a luminous element provided over said first substrate;
- a current control TFT provided over said first substrate;
- a gate control wiring provided over said first substrate for transmitting a power source signal of a gate driver circuit, a clock signal or a start signal;
- a second substrate;
- a gate control auxiliary line provided over said second substrate and electrically connected to said gate control wiring;
- a conductor for electrically connecting said gate control wiring and said gate control auxiliary line; and
- a sealing agent for bonding said first substrate and said second substrate together,

wherein the luminous element is located between the first substrate and the second substrate.

8. (Original) A device according to claim 7, wherein said luminous element is an EL element.

9. (Original) A device according to claim 7, wherein said gate control auxiliary line is made of a metallic film containing a material selected from the group consisting of copper, silver, gold, aluminum and nickel, or an alloy film containing as a main component a material selected from the group consisting of copper, silver, gold, aluminum, and nickel.

10. (Original) A device according to claim 7, wherein said gate control auxiliary line is formed into a layered structure made of a metallic film that is made of two or more different elements selected from copper, silver, gold, aluminum and nickel.

11. (Previously Presented) A device according to claim 7, wherein said gate control auxiliary line is formed on a front surface of said second substrate, on a back surface thereof, or in the interior thereof.

12. (Previously Presented) A device according to claim 7, wherein a via hole that is covered by said gate control auxiliary line is formed in said second substrate.

13. (Currently Amended) A light-emitting device, comprising:
a first substrate;

a luminous element provided over said first substrate;

a current control TFT provided over said first substrate;

a current supply line provided over said first substrate and connected with said luminous element via said current control TFT;

a second substrate;

a wiring for aiding said current supply line, said wiring for aiding said current supply line provided over said second substrate and electrically connected to said current supply line;

a conductor for electrically connecting said current supply line and said wiring for aiding said current supply line;

a sealing agent for bonding said first substrate and said second substrate together; and

a resin filled in a space between said first substrate and said second substrate,

wherein the luminous element is located between the first substrate and the second substrate.

14. (Original) A device according to claim 13, wherein said luminous element is an EL element.

15. (Original) A device according to claim 13, wherein said wiring for aiding said current supply line is made of a metallic film containing a material selected from the group consisting of copper, silver, gold, aluminum and nickel, or an alloy film containing as a main component a material selected from the group consisting of copper, silver, gold, aluminum, and nickel.

16. (Original) A device according to claim 13, wherein said wiring for aiding said current supply line is formed into a layered structure made of a metallic film that is made of two or more different elements selected from copper, silver, gold, aluminum and nickel.

17. (Previously Presented) A device according to claim 13, wherein said wiring for aiding said current supply line is formed on a front surface of said second substrate, on a back surface thereof, or in the interior thereof.

18. (Previously Presented) A device according to claim 13, wherein a via hole that is covered by said wiring for aiding said current supply line is formed in said second substrate.